

Bienvenido a O-Leading

O-Leading se esfuerza por ser su socio de solución integral en la cadena de suministro de EMS, incluido el diseño de PCB, la fabricación de PCB y el ensamblaje de PCB (PCBA). Proporcionamos algunas de las tecnologías de PCB más avanzadas, incluyendo PCB de HDI, PCB de múltiples capas, PCB rígido-flexibles. Podemos apoyar desde el prototipo de giro rápido hasta la producción media y en masa. [Empresa impresa pcb multicapa](#)

En general, nuestros clientes globales están muy impresionados con nuestros servicios: respuesta rápida, precio competitivo y compromiso de calidad. Brindar un servicio técnico más valioso y una solución general es la forma en que O-lidera.

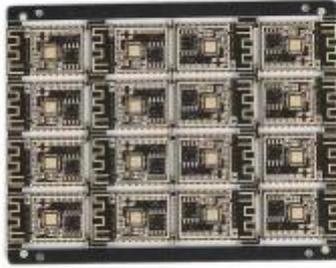
Mirando hacia el futuro, O-Leading se concentrará en la innovación y el desarrollo de la tecnología de fabricación de productos electrónicos como siempre, y realizará esfuerzos persistentes en el servicio integral de PCB y PCBA para proporcionar servicios de primera clase y crear más valor para nuestros clientes.

Haga clic en este enlace para obtener más información: [Fabricante de PCB de múltiples capas de china](#)

Descripción del producto

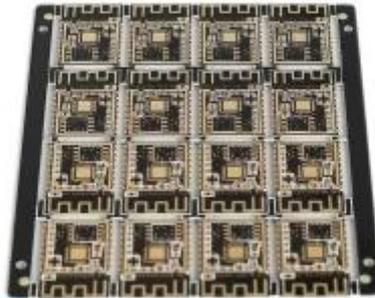
PCB P / N	sicarencia de máscara de pcb con agujero medio plateado
Recuento de capas	4L
Material	FR-4 TG170
Junta THK	1.6mm
cobre thk	1/1/1 / 1oz
Tamaño de agujero más pequeño	0.3mm
No. de agujeros (pcs)	9 98
línea w / s	5 5/ /5mil
Control de impedancia. S / N (Tol%)	norte
Acabado de superficies	ENIG Au: 0.05-0.10UM
Serigrafía de máscara de soldadura	Blanco negro
Tamaño de placa individual	Dim X (mm): 21; Dim Y (mm): 12
Panelización	Dim X (mm): 90; Dim Y (mm): 68; No de UPS: 16
Especial: máscara despegable	norte
Enrutamiento / Punzonado	CNC

O-LEADING
To Be Reliable, To Be Efficient



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Nuestro equipo



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Certificaciones

CICC INSPECTION CERTIFICATION



嘉泰认证

QUALITY MANAGEMENT SYSTEM CERTIFICATE

Certificate No: 18118Q10347R05

We hereby certify that

O-LEADING SUPPLY CHAIN(HK) CO.,LIMITED

Credit No: 61691591-000-07-18-7

Registration Add: FLAT/RM 1205 12/F TAI SANG BANK BUILDING 130-132 DES VODEUS ROAD CENTRAL HK

Business Add: 1213, Floor 13, Fortune Building, Danshui Town, Huiyang District, Huizhou, Guangdong, China

Has implemented and maintains a **Quality Management System** Which fulfills the requirements of the following standards
GB/T19001-2016 idt ISO9001:2015

Scope of certification
Sales of printed circuit boards

Initial issuance period: February 27, 2018
Renewal date: April 22, 2019
This certificate is valid during: April 22, 2019 – February 26, 2021
This certificate is invalid without CICC qualified label in the following period

First supervision and audit	Second supervision and audit	Qualified mark
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The certification registration fee does not include those production stages which fail to be covered by the relevant effective administrative procedures and qualification procedures stipulated by the client. The effectiveness of this certificate shall be restricted to those activities which are covered by the certification. The initial information of this certification can be searched on the internet of CICC www.cicc.com.cn by the site of internet www.cicc.com.cn.






CICC INSPECTION CERTIFICATION



嘉泰认证

质量管理体系认证证书

证书号: 18118Q10347R05

兹证明

诚领供应链(香港)有限公司

统一社会信用代码: 61691591-000-07-18-7

注册地址: 香港中環德輔道中130-132號大生銀行大廈1205室

经营地址: 广东惠州惠阳淡水南亨西路财富大厦13楼1313

建立的质量管理体系符合

GB/T19001-2016 idt ISO9001:2015 质量标准适用条款的要求

认证范围
印刷线路板的销售

初次获证日期: 2018年02月27日
换证日期: 2019年04月22日
证书有效期: 自2019年04月22日至2021年02月26日
在下列期限内, 未经CICC黏贴合格标贴, 本证书无效

第一次监督	第二次监督	黏贴处
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本证书认证范围不包括未取得有效的国家规定的行政许可、资质许可的产品/服务范围; 本证书通过CICC定期监督审核保持, 与年度《保持认证通知书》共同方为有效; 本证书信息可在国家认监委网站: www.cnca.gov.cn及CICC网站www.cicc.com.cn查询。








Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ
Date of Sample Received : 22 Mar 2019
Testing Period : 22 Mar 2019 - 30 Mar 2019
Test Requested : Selected test(s) as requested by client.
Test Method : Please refer to next page(s).
Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina
Tina Fan
Approved Signatory



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Test Report

No. SZXEC1900530401 Date: 30 Mar 2019 Page 2 of 6

Test Results :

Test Part Description :

Table with 3 columns: Specimen No., SGS Sample ID, Description. Row 1: SN1, SZX19-005304.001, Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
(2) MDL = Method Detection Limit
(3) ND = Not Detected (< MDL)
(4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Table with 5 columns: Test Item(s), Limit, Unit, MDL, 0/1. Lists various substances like Cadmium, Lead, Mercury, Hexavalent Chromium, Sum of PBBs, Monobromobiphenyl, etc.



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ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width			SS/ DS/ DSO	Max	Max			Meets UL796	C T	
	Min	Cond	Area		Solder	Flame	Class				
	Min	Edge			Thk			Oper			
mm(in)	mm(in)	mic(mil)	Diam	Limits	Temp	DSR	I				
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲	*
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Capacidad de procesamiento

Capacidades de producción de PCB

Recuento de capas: 1 capa-32 capas

Espesor de cobre acabado: 1/3 oz-12 oz

Ancho mínimo de línea / espaciado interno: 3.0mil / 3.0mil

Ancho mínimo de línea / espaciado externo: 4.0mil / 4.0mil

Relación de aspecto máxima: 10: 1

Grosor del tablero: 0.2mm-5.0mm

Tamaño máximo del panel (pulgadas): 635 * 1500 mm

Tamaño mínimo del orificio perforado: 4mil

Tolerancia de agujero revestido: +/- 3mil

Blind / Vias enterradas (tipos All): Sí

Vía relleno (conductor, no conductor): Sí

Material base: FR-4, material libre de halógenos de alta Tg. FR-4, Rogers, base de aluminio, Poliimida, Cobre pesado

Acabados superficiales: HASL, OSP, ENIG, HAL-LF, plata de inmersión, Inmersión de estaño, dedos dorados, tinta de carbono

Capacidades de producción SMT

Material de PCB: FR-4, CEM-1, CEM-3, placa a base de aluminio

Tamaño máximo de PCB: 510x460 mm

Tamaño mínimo de PCB: 50x50mm

Grosor de PCB: 0.5mm-4.5mm

Grosor del tablero: 0.5-4 mm

Tamaño mínimo de componentes: 0201

Componente de tamaño de chip estándar: 0603 y más grande

Altura máxima del componente: 15 mm

Paso de plomo mínimo: 0.3 mm

Paso mínimo de bola BGA: 0.4 mm

Precisión de colocación: +/- 0.03 mm